LEADER TIME SRL

PRODUCT SPECIFICATION

16*2 Characters COB LCD MODULE
MODEL: LT-1602E-202 Ver:1.1

< ◇ > Finally Specification

CUSTOMER'S APPROVAL	
CUSTOMER :	
SIGNATURE:	**DATE:**

APPROVED BY	PM REVIEWD	PD REVIEWD	PREPARED By

Prepared By:

LEADER TIME SRL

VIA MONS. PROSDOCIMI, 27

36042 BREGANZE (VI)

● This specification is subject to change without notice. Please contact LT or its representative before designing your product based on this specification.

Revision Status

Version	Revise Date	Page	Content	Modified By
Ver 1.0	2016/04/21		First Issued	
Ver 1.1	2017/10/24		Change IC	

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1. Features

The features of LCD are showed as follows

* Display mode   : STN/Yellow-Green/Transflective/Positive
* Controller IC   : UCI7066-01(English-Japanese)
* Display format   : 16X2 Characters
* Interface Input Data : 4 bit or 8 bit MPU
* Driving Method   : 1/16Duty, 1/5Bias
* Viewing Direction : 12 O'clock
* Backlight   : LED/Bottom/Yellow-Green
*Sample NO.   :C1602A4SBY7B-L0_02/20171013

2. MECHANICAL SPECIFICATIONS

Item	Specification	Unit
Module Size	122(W) x44(H) x13.3MAX(D)	mm
Viewing Area	99(W) x 25(H)	mm
ActivityDisplay Area	95.2(W)x20(H)	mm
Character Font	5x8 Dots	-
Character Size	5.2(W)x9.55(H)	mm
Character Pitch	6(W)x10.45(H)	mm
Dot Size	1(W)x1.15(H)	mm

3. ELECTRICAL SPECIFICATIONS

3-1 ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Item	Symbol	Min	Max	Unit
Supply Voltage For Logic	V_{DD}	-0.3	+7.0	V
Supply Voltage For LCD Drive	V_{LCD}	V_{DD}-15.0	V_{DD}+0.3	V
Input Voltage	Vin	-0.3	V_{DD}+0.3	V
Operating Temp.	Top	-20	+70	°C
Storage Temp.	Tst	-30	+80	°C

*. NOTE: The response time will be extremely slow when the operating temperature isaround -10℃, and the back ground will become darker at high temperature operating.

3-2 ELECTRICAL CHARACTERISTICS

Item		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Logic supply Voltage		V_{DD} – Vss		4.5	5	5.5	V
LCD Drive		$V_{OP}=V_{DD}$ –V0	Ta = 25 °C VDD=5V $\pm$ 10 %	-	4.5	-	V
Input Voltage	"H" Level	V IH1		$0.7V_{DD}$	-	V_{DD}	V
	"L" Level	V IL1		-0.3	-	0.6	V
Frame Frequency		f FLM		-	75	-	Hz
Current Consumption		I DD		-	2.3	-	mA

3-3 BACKLIGHT

3-3-1. Absolute Maximum Ratings

Item	Symbol	Condition	min	Typ	Max	Unit
Forward Current	IF	Ta = 25 °C	-	-	24*20	mA
Power Dissipation	PD		-	-	48*50	mW
ReverseCurrent	Ir	Vr=10.0V	-	-	240	uA

3-3-2. Electrical-optical Characteristics

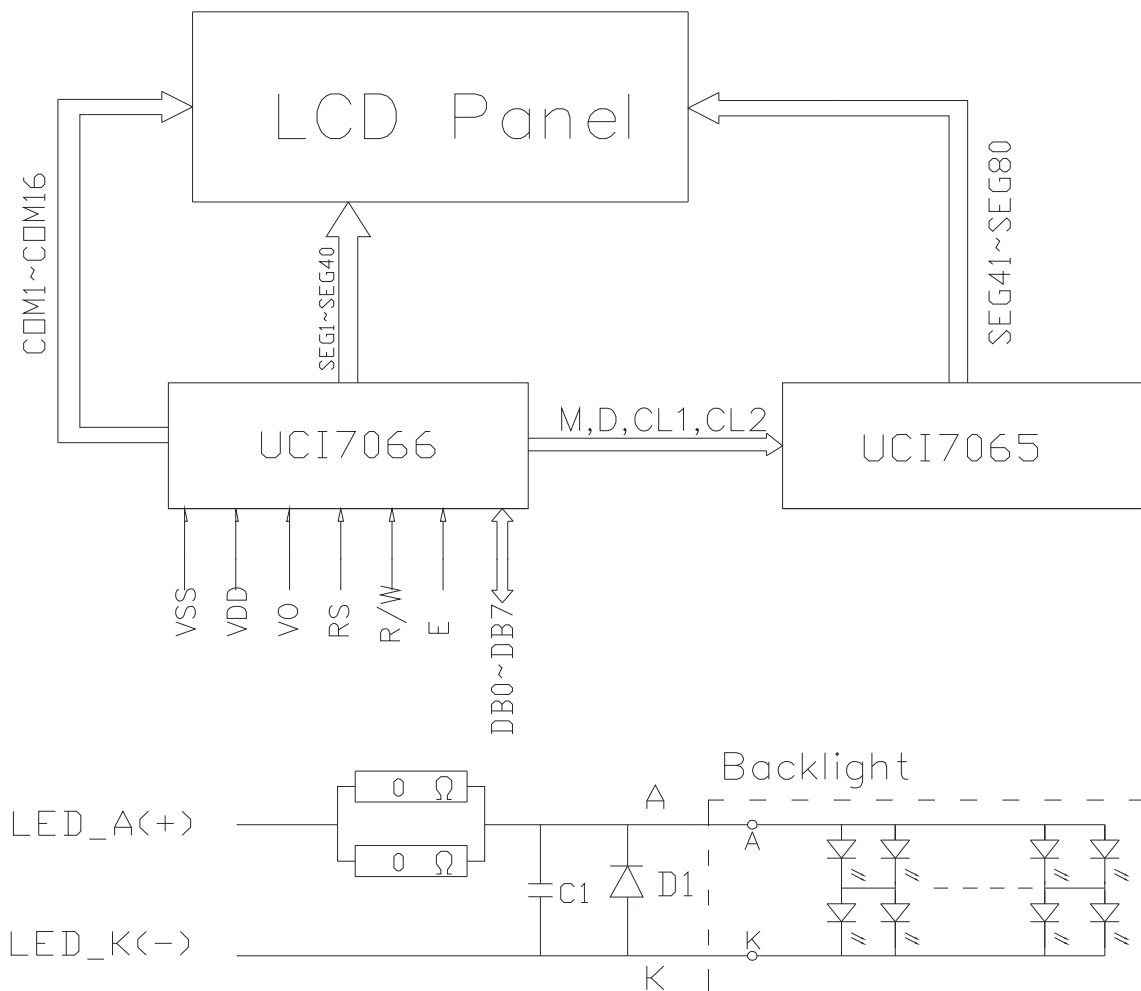| Item	Symbol	Condition	min	Typ	Max	Unit
Forward Voltage	VF	If=240mA Ta = 25 °C	3.6	4.2	4.6	V
Average Luminous Intensity	Lv		120	-	-	cd/m^2
Dominant wave length	λ P		570	572	575	nm

The brightness is measured without LCD panel

For operation above 25 °C,TheIfm&Pd must be derated , the current derating is -0.36*24mA/°C for DC drive and -0.86*24mA/°C for Pulse drive ,the Power dissipation is -0.75*24mW/°C.The product working current must not more than the 60% of the Ifm or Ifp according to the working temperature.

4. TERMINAL FUNCTIONS AND BLOCK DIAGRAM

4-1 INTERFACE PIN FUNCTION DESCRIPTION

| PIN NO.	SYMBOL	FUNCTIONS
1	LED_K	Backlight-
2	LED_A	Backlight+(240mA)
3	VSS	Ground
4	VDD	Supply voltage for logical circuit
5	V0	Supply voltage for LCD driving
6	RS	A signal for selecting registers. 1: Data Register (for read and write) 0: Instruction Register (for write)
7	R/W	A signal for selecting read or write actions.1: Read, 0: Write.
8	E	Aenable signal for reading or writing data.
9~16	DB0~DB7	8 Bit Data Bus

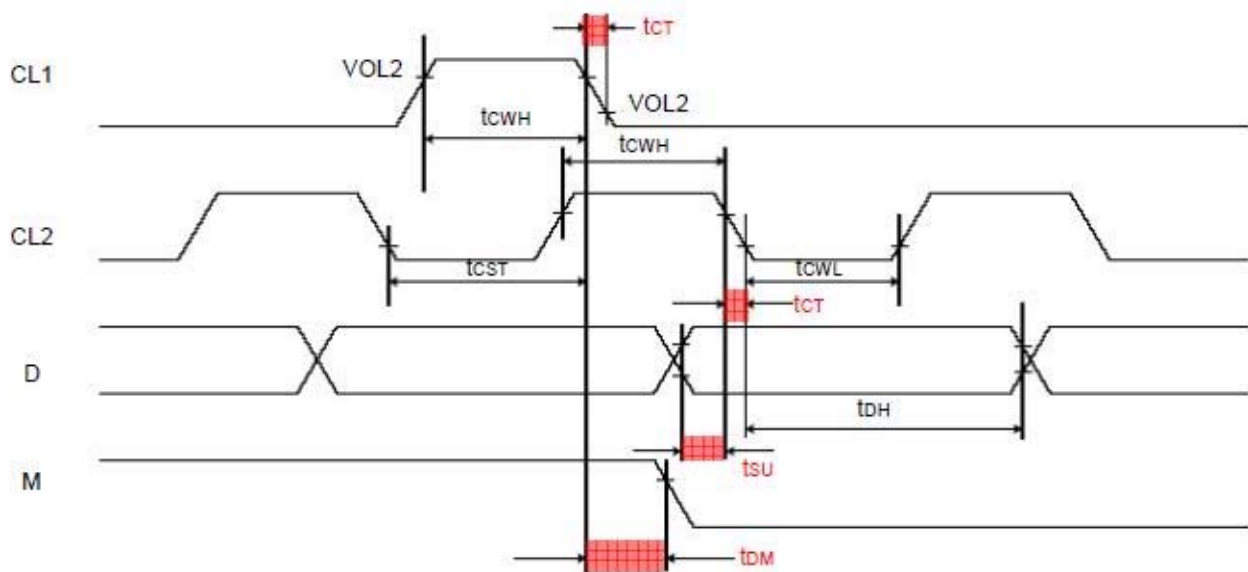## 4-2 BLOCK DIAGRAM

5. TIMING CHARACTERISTICS
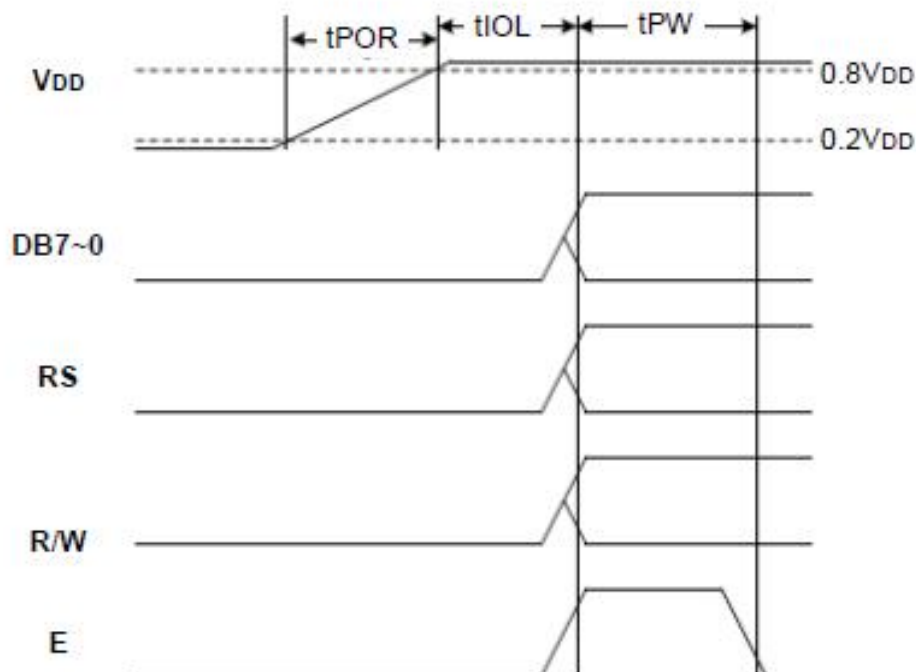
5-1 Reading data from UCI7066U to MPU
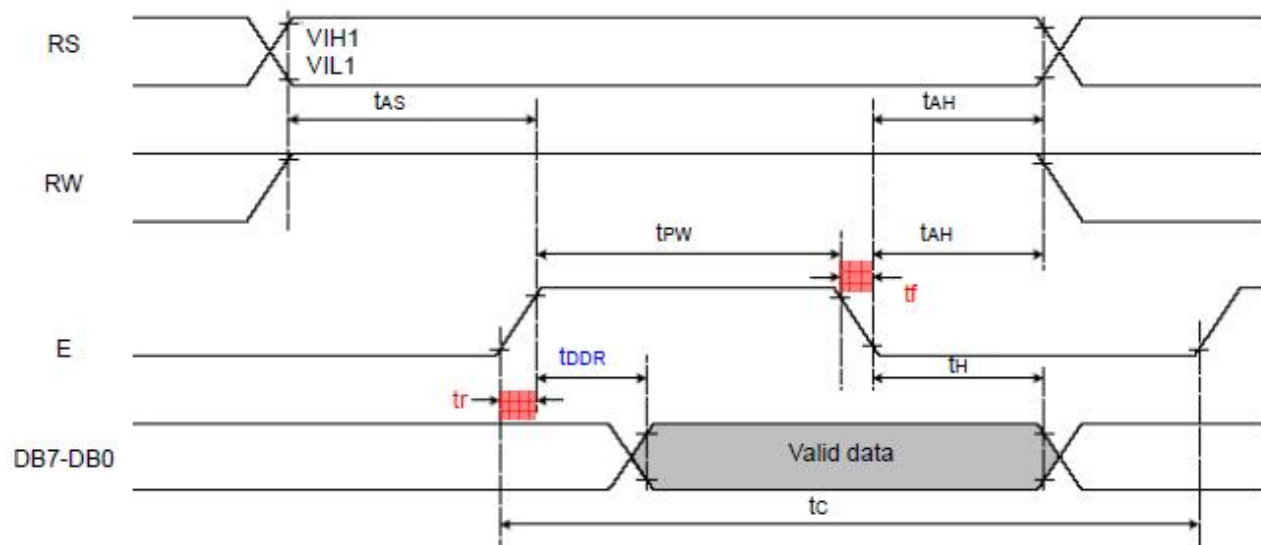
5-2 Writing data from MPU to UCI7066U
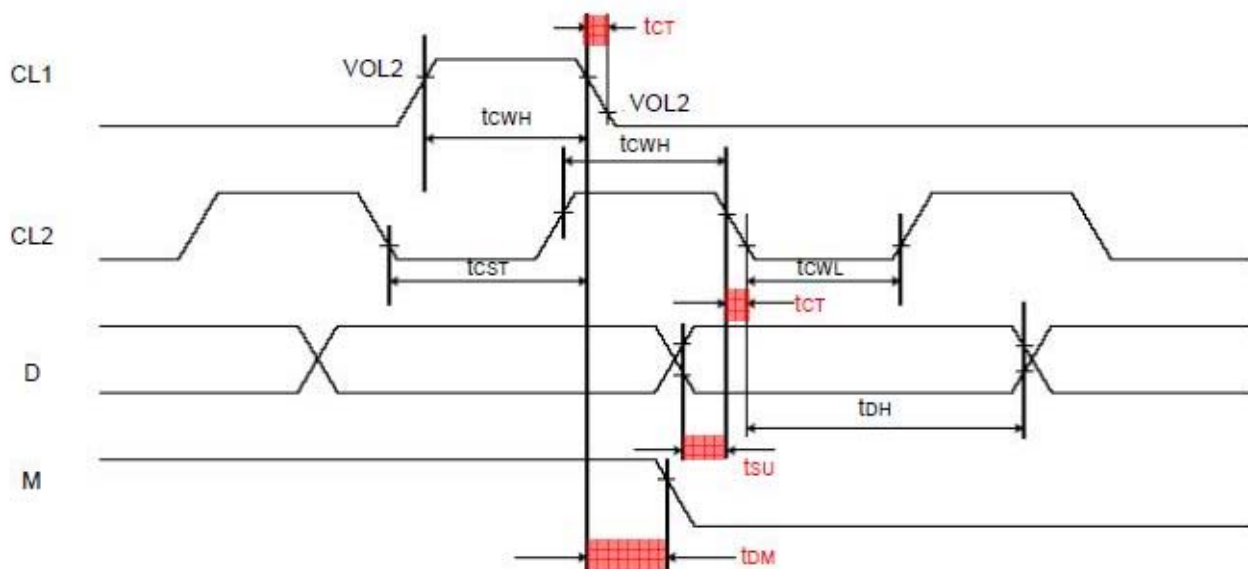
5-3 With External Driver

5-4 Power Supply Conditions

Symbol	Characteristics	Description	Min	Typ.	Max.	Unit
tPOR	Power Rise time	Power rise time that will trigger internal POR circuit	0.1		100	mS
tIOL	I/O Low time	The period that I/O is kept LOW	40			mS
tPW	Enable Pulse width	Please refer to the following tables				

5-5 Parameter

$T_A = 25^\circ C$, Vcc=4.5V~5V

Symbol	Characteristic	Test Condition	Min.	Typ.	Max.	Unit
Internal Clock Operation						
fosc	OSC Frequency	R=91KΩ	190	270	350	KHz
External Clock Operation						
fEX	External Frequency	--	125	270	410	KHz
	Duty Cycle	--	45	50	55	%
tR, tF	Rising/Falling Time	--	--	--	0.2	uS
Write Mode (MPU writes data to UCi7066)						
tc	Enable Cycle Time	Pin E	1200	--	--	nS
tpw	Enable Pulse Width	Pin E	140	--	--	nS
tR, tF	Rising/Falling Time	Pin E	--	--	25	nS
tAS	Address Setup Time	Pin: RS, RW, E	0	--	--	nS
tAH	Address Hold Time	Pin: RS, RW, E	10	--	--	nS
tDSW	Data Setup Time	Pin: DB7~DB0	40	--	--	nS
tH	Data Hold Time	Pin: DB7~DB0	10	--	--	nS
Read Mode (MPU reads data from UCi7066)						
tc	Enable Cycle Time	Pin E	1200	--	--	nS
tpw	Enable Pulse Width	Pin E	140	--	--	nS
tR, tF	Rising/Falling Time	Pin E	--	--	25	nS
tAS	Address Setup Time	Pin: RS, RW, E	0	--	--	nS
tAH	Address Hold Time	Pin: RS, RW, E	10	--	--	nS
tDDR	Data Setup Time	Pin: DB7~DB0	--	--	100	nS
tH	Data Hold Time	Pin: DB7~DB0	10	--	--	nS
Interface Mode with LCD Driver (UCi7065)						
tCWH	Clock Pulse Width, High	Pin: CL1, CL2	800	--	--	nS
tCWL	Clock Pulse Width, Low	Pin: CL1, CL2	800	--	--	nS
tCST	Clock Setup Time	Pin: CL1, CL2	500	--	--	nS
tSU	Data Setup Time	Pin: D	300	--	--	nS
tDH	Data Hold Time	Pin: D	300	--	--	nS
tDM	M Delay Time	Pin: M	0	--	2000	nS

6.COMMAND LIST

The following is a list of host commands supported by UCi7066

R/S : 0: Control, 1: Data   W/R : 0: Write Cycle, 1: Read Cycle   D7-D0 :   –: Don't Care

#	Command	RS	R/W	D7	D6	D5	D4	D3	D2	D1	D0	Action
1	Clear Display	0	0	0	0	0	0	0	0	0	1	Clear the screen
2	Return Home	0	0	0	0	0	0	0	0	1	–	Move cursor to HOME
3	Set Entry Mode	0	0	0	0	0	0	0	1	I/D	S	I/D: Left / Right S: Shift OFF/ON
4	Display ON/OFF	0	0	0	0	0	0	1	D	C	B	D: Display OFF / ON C: Cursor OFF / ON B: Blink OFF / ON
5	Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	–	–	S/C: Screen / Cursor R/L Right / Left
6	Set Function	0	0	0	0	1	DL	N	F	–	–	DL: 4-bit / 8-bit, N: 1-line / 2-line F: 5x8 / 5x11
7	Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	
8	Set DDRAM address	0	0	1	AC12	AC11	AC10	AC9	AC8	AC7	AC6	
9	Read Busy Flag and address	0	1	BF	AC19	AC18	AC17	AC16	AC15	AC14	AC13	
10	Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data to RAM
11	Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from RAM
For S8/S9 Mode												
12	Status Read	1	1	0	0	0	0	0	0	0	0	Read status
		0	1	BF	AC19	AC18	AC17	AC16	AC15	AC14	AC13	

Note:

Ensure that UCi7066 is not in the BUSY state (BF = 0) before sending an instruction from the MPU to the UCi7066. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

7.CHARACTER GENERATOR ROM

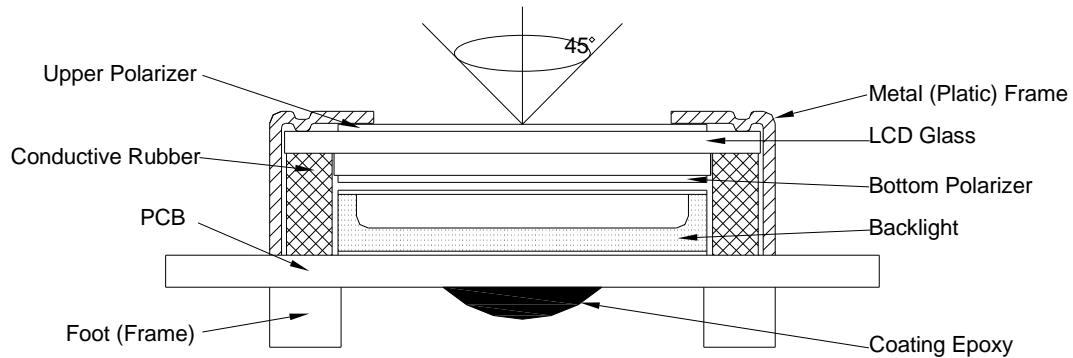Correspondence between Character Codes and Character Patterns (ROM Code: 0A)   No. 7066-01

8. QUALITY SPECIFICATIONS

8-1. LCM Appearance and Electric inspection Condition

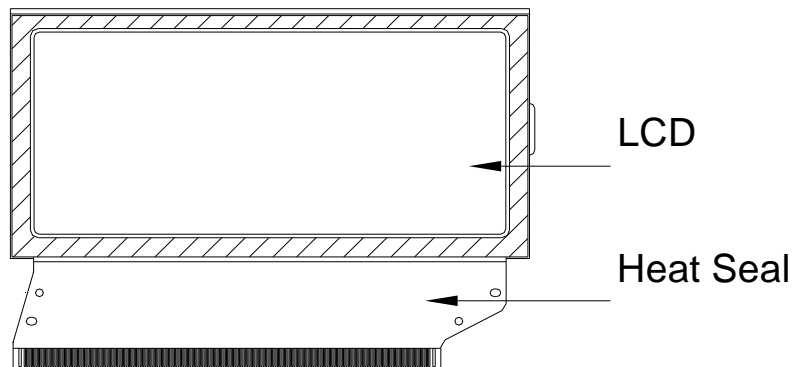**1. Inspection will be done by placing LCM 30cm away from inspector's eyeballs under normal illumination.**

Upper Polarizer — Metal (Platic) Frame
— LCD Glass
Conductive Rubber — Bottom Polarizer
PCB — Backlight
45°
Foot (Frame) — Coating Epoxy

2. View Angle: with in 45°around perpendicular line.

8-2. Definition

1. COB

PCB
Metal (Plastic) Frame
LCD

2. Heat Seal

LCD

Heat Seal

3. TAB and COG

LCD Glass
ITO Terminal Pad
IC

TAB

LCD Glass
IC
Pin
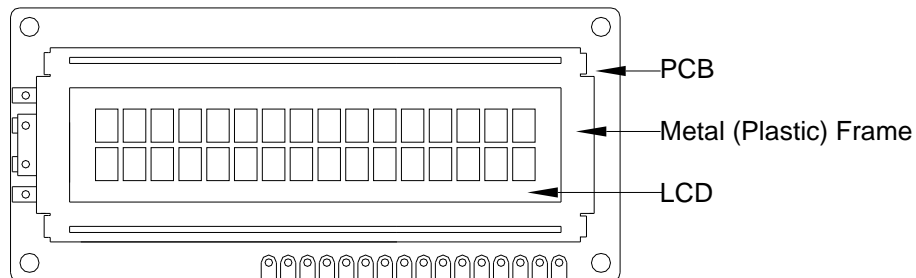
COG
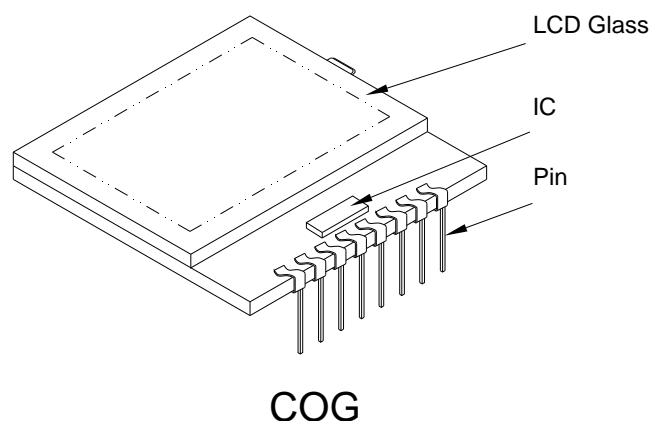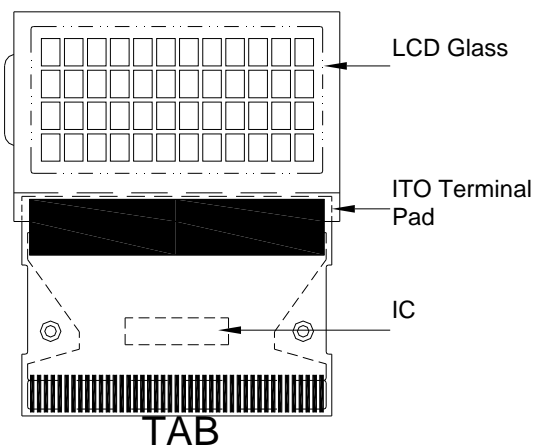
8-3. Sampling Plan and Acceptance

1. Sampling Plan
   MIL - STD - 105E (‖) ordinary single inspection is used.
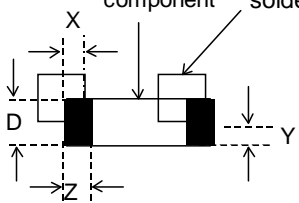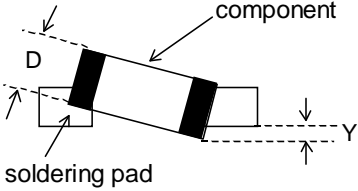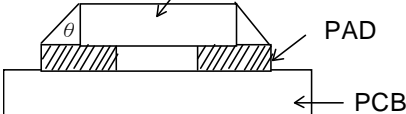2. Acceptance
   Major defect: AQL = 0.65%
   Minor defect: AQL = 1.5%

8-4. Criteria

1. COB

Defect	Inspection Item	Inspection Standards	
Major	PCB copper flakes peeling off	Any copper flake in viewing Area should be greater than 1.0mm^2	Reject
Major	Height of coating epoxy	Exceed the dimension of drawing	Reject
Major	Void or hole of coating epoxy	Expose bonding wire or IC	Reject
Major	PCB cutting defect	Exceed the dimension of drawing	Reject
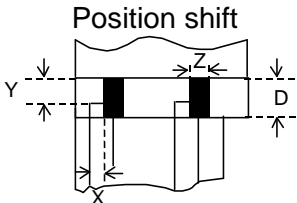
2. SMT

Defect	Inspection Item	Inspection Standards	
Minor	Component marking not readable		Reject
Minor	Component height	Exceed the dimension Of drawing	Reject
Major	Component solder defect (missing , extra, wrong component or wrong orientation		Reject
Minor	Component position shift	$X < 3/4Z$ $Y > 1/3D$	Reject Reject
Minor	Component tilt	$Y > 1/3D$	Reject
Minor	Insufficient solder	$\theta \leq 20°$	Reject

3. Metal (Plastic) Frame

Defect	Inspection Item	Inspection Standards		
Major	Crack / breakage	Anywhere		Reject
Minor	Frame Scratch	W	L	Acceptable of Scratch
		w<0.1mm	Any	Ignore
		$0.1 \leq$ w<0.2mm	L$\leq$5.0mm	2
		$0.2 \leq$ w<0.3mm	L$\leq$3.0mm	1
		w$\geq$0.3mm	Any	0
		Note : 1. Above criteria applicable to scratch lines with distance greater than 5mm. 2. Scratch on the back side of frame (not visible) can be ignored .		
Minor	Frame Dent , Prick $\Phi = \dfrac{L + W}{2}$			Acceptable of Dents / Pricks
		$\Phi \leq 1.0$mm		2
		$1.0 < \Phi \leq 1.5$mm		1
		1.5mm$< \Phi$		0
		Note : 1. Above criteria applicable to any two dents / pricks with distance greater than 5mm 2. Dent / prick on the back side of frame (not visible) can be ignored		
Minor	Frame Deformation	Exceed the dimension of drawing		
Minor	Metal Frame Oxidation	Any rust		
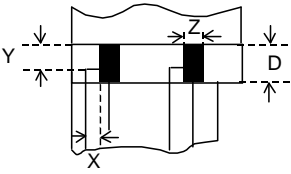
4. Flexible Film Connector (FFC)

Defect	Inspection Item		Inspection Standards	
Minor	Tilted soldering		Within the angle +5°	Acceptable
Minor	Uneven solder joint /bump			Reject
Minor	Hole	$\Phi = \dfrac{L + W}{2}$	Expose the conductive line	Reject
			$\Phi > 1.0$mm	Reject
Minor	Position shift		Y > 1/3D	Reject
			X > 1/2Z	Reject

5. Screw

Defect	Inspection Item	Inspection Standards	
Major	Screw missing/loosen		Reject
Minor	Screw oxidation	Any rust	Reject
Minor	Screw deformation	Difficult to accept screw driver	Reject

6. Heatseal、TCP 、FPC

Defect	Inspection Item	Inspection Standards	
Major	Scratch expose conductive layer		Reject
Minor	HS Hole $\Phi = \dfrac{L + W}{2}$	$\Phi > 0.5mm$	Reject
Major	Adhesion strength	Less than the specification	Reject
Minor	Position shift	$Y > 1/3D$	Reject
		$X > 1/2Z$	Reject
Major	Conductive line break		Reject
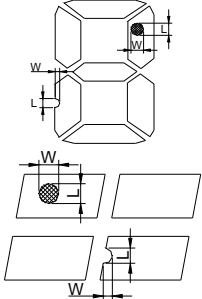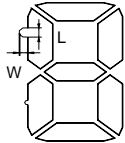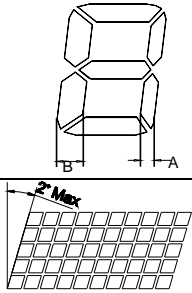
7. LED Backing Protective Film and Others

Defect	Inspection Item	Inspection Standards	
Minor	LED dirty, prick	Acceptable number of units	
		$\Phi \leq 0.10mm$	Ignore
		$0.10 < \Phi \leq 0.15mm$	2
		$0.15 < \Phi \leq 0.2mm$	1
		$\Phi > 0.2mm$	0
		The distance between any two spots should be $\geq 5mm$ Any spot/dot/void outside of viewing area is acceptable	
Minor	Protective film tilt	Not fully cover LCD	Reject
Major	COG coating	Not fully cover ITO circuit	Reject

8. Electric Inspection

Defect	Inspection Item	Inspection Standards	
Major	Short		Reject
Major	Open		Reject

9. Inspection Specification of LCD

Defect	Inspect Item	Inspection Standards			
Minor	Linear Defect ∗Glass Scratch ∗Polarizer Scratch ∗ Fiber and Linear material	W	W≤0.03	0.03<W≤0.05	W>0.05
		L	L<5	L<3	Any
		ACC. NO.	1	1	Reject
		Note	L is the length and W is the width of the defect		

Defect	Inspect Item	Inspection Standards			
Minor	Black Spot and Polarizer Pricked ∗ Foreign material between glass and polarizer or glass and glass ∗ Polarizer hole or protuberance by external force	Φ	Φ≤0.1	0.1<Φ≤0.15	0.15<Φ≤0.2	Φ>0.2
		ACC. NO.	3EA / 100mm^2	2	1	0
		Note	Φ is the average diameter of the defect. Distance between two defects >10mm.			

Defect	Inspect Item	Inspection Standards			
Minor	White Spot and Bubble in polarizer ∗ Unobvious transparant foreign material between glass and glass or glass and polarizer ∗ Air protuberance between polarizer and glass	Φ	Φ≤0.3		0.3<Φ≤0.5	0.5<Φ
		ACC. NO.	3EA / 100mm^2		1	0
		Note	Φ is the average diameter of the defect. Distance between two defects >10mm.			

Segment Defect (Minor)

Φ	Φ≤0.10	0.10<Φ≤0.20	0.20<Φ≤0.25	Φ>0.25
ACC. NO.	3EA / 100mm^2	2	1	0

	W is more than 1/2 segment width	Reject
Note	$\Phi = \dfrac{L + W}{2}$ Distance between two defect is 10mm	

Protuberant Segment (Minor)

$\Phi = (L + W) / 2$

Φ	Φ≤0.10	0.10<Φ≤0.20	0.20<Φ≤0.25	Φ>0.25
W	Glue	W≤1/2 Seg W≤0.2	W≤1/2 Seg W≤0.2	Ignore
ACC. NO.	3EA / 100mm^2	2	1	0

Assembly Mis-alignment (Minor)

1. Segment

B	B≤0.4mm	0.4<B≤1.0mm	B>1.0mm
B-A	B-A<1/2B	B-A<0.2	B-A<0.25
Judge	Acceptable	Acceptable	Acceptable

2. Dot Matrix

Deformation>2°	Reject

Defect	Inspect Item	Inspection Standards
Minor	Stain on LCD Panel Surface	Accept when stains can be wiped lightly with a soft cloth or a similar one. Otherwise, judged according to the above items: "Black spot" and "White Spot"

9. RELIABILITY

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	60℃, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20℃, 60min~70℃, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X,Y,Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air:±8KV 150pF/330Ω 5 times Contact:±4KV 150pF/330Ω 5 times	2	GB/T17626.2 -2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note:1) Above conditions are suitable for our company standard products.
   2) For restrict products, the test conditions listed as above must be revised.

10. HANDLING PRECAUTION

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers
which easily getdamaged since the Module is fixed by utilizing fitting holesin the printed
circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.
- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifloro thane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:
- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input
terminal to VDD or VSS, do not input any signals before power is turned on. Andground your body,
Work/assembly table. Andassemblyequipment toprotect against staticelectricity.

(4) Packaging

- Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.
- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or
high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the
limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration,
Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range
and on the other hand at higher temperature LCD's show dark color in them.However those
phenomena do not mean malfunction or out of order with LCD's. Which will come back in the specified
operating temperature range.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it
resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open
circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance.) For years) for the purpose or replacement
use, The following ways are recommended.
- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no
desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is. Keeping temperature in
the specified storage temperature range.
- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as
they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal
by using solvents such as acetone and ethanol.Which should be burned up later.

When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please
wash it off well with soap and water.

(8) Other

- After the product shipped,any product quality issues must be feedback within three
months,otherwise,we will not be responsible for the subsequent or consequential events.

11. OUTLINE DIMENSION

NOTE:The dimension with"( )" is reference

Pin assignment

NO.	Symbol
1	LED_K
2	LED_A
3	VSS
4	VDD
5	V0
6	RS
7	R/W
8	E
9	DB0
10	DB1
11	DB2
12	DB3
13	DB4
14	DB5
15	DB6
16	DB7

Detail Dots
Scale 2:1

REVISION RECORD

REV			APPROVED
A	First Issue		
B	Modify IC		
C	Modify IC		

MODEL NAME:
DATE 2017.08.03
VERSION C
UNIT mm
TITLE: Outline
NO. 1/1
SCALE
DRAWN
CHECKED
APPROVED
FILE NAME: